SIMADYN D Digital Control System

User Manual

EP3/EP3.1 Signal Processor



User Manual, EP3/EP3.1 Signal Processor Module

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We have checked the contents of this Manual to ensure that they coincide with the described hardware and software. However, deviations cannot be completely ruled-out, so we cannot guarantee complete conformance. However, the information in this document is regularly checked and the necessary corrections included in subsequent editions. We are thankful for any recommendations or suggestions.

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NOTE!

The information in this Manual does not purport to cover all details or variations in equipment, nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired or should particular problems arise which are not covered sufficiently for the purchaser's purposes, please contact your local Siemens office.

Further, the contents of this Manual shall not become a part of or modify any prior or existing agreement, committment or relationship. The sales contract contains the entire obligation of Siemens. The warranty contained in the contract between the parties is the sole warranty of Siemens. Any statements contained herein do not create new warranties nor modify the existing warranty.

Warning information



Definitions

* QUALIFIED PERSONNEL

For the purpose of this User Manual and product labels, a "Qualified person" is someone who is familiar with the installation, mounting, start-up and operation of the equipment and the hazards involved. He or she must have the following qualifications:

1. Trained and authorized to energize, de-energize, clear, ground and tag circuits and equipment in accordance with established safety procedures.

2. Trained in the proper care and use of protective equipment in accordance with established safety procedures.

3. Trained in rendering first aid.

* DANGER

For the purpose of this User Manual and product labels, "Danger" indicates death, severe personal injury and/or substantial property damage will result if proper precautions are not taken.

* WARNING

For the purpose of this User Manual and product labels, "Warning" indicates death, severe personal injury or property damage can result if proper precautions are not taken.

* CAUTION

For the purpose of this User Manual and product labels, "Caution" indicates that minor personal injury or material damage can result if proper precautions are not taken.

* NOTE

For the purpose of this User Manual, "Note" indicates information about the product or the respective part of the User Manual which is essential to highlight.



WARNING!
Hazardous voltages are present in this electrical equipment during operation. Non-observance of the safety instructions can result in severe personal injury or property damage. It is especially important that the warning information in all of the relevant Operating Instructions are strictly observed.

1. Ordering data

EP3: 6DD 1645- 0AE0 EP3.1: 6DD 1645- 0AE1

2. Function description

The SIMADYN D system is especially suitable for especially fast closed-loop control and arithmetic operations, special converter-related functions, including gating unit and for fast analog signal processing (digital filter).

The EP3/3.1 has a DSP56002 signal processor, whose functions can be configured using STRUC, as well as interfaces to plug-in technology cards, with which the peripheral hardware can be optimally adapted to the particular task.

3. Board design



- * DSP56002 signal processor with 54 MHz clock frequency for EP3
- * DSP56002 signal processor with 66 MHz clock frequency for EP3.1
- * 128k x 24 bit working memory
- * 3 LCAs XC4013 for interrupt processing, signal pre-processing and fast logic functions (gating unit or similar)
- * Serial Communication Controller 85C30 for serial communications (2 channels for 2 plug-in cards)
- * Communications via L bus via 4k x 16 bit dual port RAM
- * Watchdog for fault identification and processor monitoring withdraws *RDYIN, if the DSP no longer reads or writes (*RDYIN is accessed at MM3, MM4)

4. Application information

For perfect functioning, the board must be screwed-into the subrack (also during start-up).

4.1. Plug-in technology cards

Plug-in technology cards are required in order to fully-utilize the special characteristics and features of the EP3/3.1. These provide the hardware for the particular application (e.g. fast and accurate analog inputs for digital filters, firing pulse output for the gating unit).

An EP3/3.1 can be equipped with a max. of 2 plug-in cards. They are screwed to one another and to the EP3/3.1 using distance studs, to form a single mechanical unit. An LCA design, tailored to the particular plug-in card belongs to each card, as a plug-in card is connected to the DSP via an LCA on the EP3/3.1. A function block, which runs on the DSP, communicates with the LCA, and the LCA then controls the hardware on the plug-in card. Further, the LCA can be used to implement many logic functions thus relieving the DSP.



The diagram shows that plug-in card 1 is controlled from LCA-B, and plug-in card 2, which is connected to EP3/3.1 via an adapter, from LCA-C.

The configuration for an LCA is stored in a file, which is linked with it, when the DSP program is generated. The DSP then configures the LCA for the particular application when it runs-up.

Presently, the following plug-in cards and associated LCA designs and function blocks are available:

IM1:

9 analog inputs, manual adjustment, manual setting of the limiting frequency16 binary inputs and 16 binary outputs, floating (electrically isolated), no serial interface

Can only be used as the 1st plug-in card

Width: 1 slot

With LCA design and function blocks for analog input and binary I/O

IT1:

9 analog inputs, manual adjustment, manual setting of the limiting frequency 16 pulse outputs, non-floating (no electrical isolation) with a readback device for short-circuit identification 1 analog output for pulse ???? No serial interface SS Can only be used as the 1st plug-in card Width: 1 slot With LCA designs and function blocks for analog input and for various gating units

IM3:

9 analog inputs, automatic adjustment, software setting of the limiting frequency16 binary inputs and 16 binary outputs, floating (with electrical

isolation) Serial interface V.24 can be used depending on the function

block Zero crossover sensing for phase- and phase-to-phase voltages

Width: 1 slot With LCA design and function blocks for analog input and binary

I/O, extinction angle measurement, HGÜ-DUST

IO3:

For optimal signal transfer

10 fiber-optic connections with optical/electrical converters 10 analog outputs

10 optical channels can be evaluated on which laser-modulated telegrams with measured values can be transferred, output at analog outputs and at EP, only in conjunction with a special laser board and special measured value transducer

Width: 2 slots with LCA design and function block

ID3:

Only in conjunction with IO3, received data is transferred to additional EP3/3.1 without D/A- and A/D conversion.

4.2. Configuring

- * Operation with P16- and/or P32 modules
- * Communications with PM via communication blocks
- * Initialization- and communication FBs included in the standard SIMADYN D library
- * 7 different sampling times, 0.1 ms to 5 s
- * per sampling time, 1 function package
- * 21 interrupt events, 7 special interrupts via interrupt controller and operating system
- * 1 free interrupt input on the DSP for special applications
- Number of function blocks is dependent on the computation time and sampling time (e.g. computation time for sophisticated closed-loop controls and gating unit with approx. 70 FBs: 100 µs)
- * Configuring and documentation under STRUC G with special user function block library, which
- includes the FBs for the EP3/3.1
- * Compilation, linking and sub-module programming using the EP3/3.1 compiler EP3C, additionally
- required: Motorola DSP Development Software
- * MS5 and MS55 program memory modules for user- and system software



4.3. Commissioning

The EP3 IBS program (start-up program) is available for service and diagnostics. This program can run on PCs or PGs under DOS or under a DOS shell under Windows.

Using this program, values and connections can be viewed, and temporarily or permanently modified. Operator control is realized via a dialog window with FP name, FB name, connector. Further, the EP3 IBS program provides a hexadecimal monitor, which can be used to directly access the DSP memory area.

The diagnostics interface of the EP3/3.1 is connector X5, a 9-pin sub-D socket connector.

Connecting cable	EP3/3.1		PC/F	PG	
EP3/3.1 - PC/PG:	<u>9-pin cor</u>	nnector	9-pir	n socket	25-pin plug connector/socke
	2	at	3	or	2
	3	at	2	or	3
	5	at	5	or	7

5. Technical data

5.1. General information

INSULATION GROUP

AMBIENT TEMPERATURE STORAGE TEMPERATURE HUMIDITY CLASS acc. to DIN 40040 ALTITUDE RATING acc. to DIN 40040 S DEGREE OF PROTECTION acc. to DIN 40050 MECHANICAL STRESSING PACKAGING SYSTEM DIMENSIONS BOARD WIDTH WEIGHT acc. to VDE 0110 Degree of pollution 2 Insulating material class IIIa 0 to 55 $^{\circ}$ C -40 to 70 $^{\circ}$ C F IP00 acc. to SN 29010 Class 12 ES 902 C 233:4mm*220mm 1 1/3 SPS = 1 slot width = 20.14mm approx. 500g

5.2. Current drain

CURRENT DRAIN P5	1.0 A	+ plug-in card(s)
CURRENT DRAIN P15	55 mA	+ plug-in card(s) + load at X7
CURRENT DRAIN N15	55 mA	+ plug-in card(s) + load at X7

5.3. Binary inputs (connector X6)

No. type	8, non-floating
Input voltage, nominal	24 V nominal value
for 0 signal	-1 V to + 6 V or open-circuit inputs
for 1 signal	+13 V to +33 V
Input current	
for 0 signal	0 mA
for 1 signal	3 mA typ.
Input time constant	1 μs

5.4. Binary outputs (connector X6)

No. type		4	4, non-floating	
Power supply v	oltage	(external	
	nominal value		24 V	
	ripple	:	3.6 V	
	permissible range	-	+20 V to +30 V incl.	ripple
	briefly	-	+ 35 V, max. 0.5 s	
Output current	for a 1 signal			
	nominal value	į	50 mA	
	permissible range	(0.2 mA to 50 mA	
Short-circuit protection		I	Electronic, thermal	
Residual current		2	20 μA for 0 signal	
Signal level	for 0 signal	ı	max. 3 V	
-	for 1 signal	I	Pext - 2.5 V	
Switching delay		I	max. 15 μs	

5.5. Analog outputs (connector X7)

No., type Output voltage range Output current Short-circuit current Resolution max. offset error 8, non-floating -10 V to +10 V max. 20 mA max. 60 mA 12 bits incl. sign +/-4 LSB

6. Connector assignments

6.1. Connector X5

9-pin sub-D socket connector, V.24 interface for diagnostics

Signal		
Shield		
RxD		
TxD		
GND		
GND		

6.2. Connector X6

15-pin micro-sub-D socket connector (three-row), binary inputs and outputs

Pin	Signal	Pin	Signal	Pin	Signal
1	Input 1	6	Input 5	11	Output 5
2	Input 2	7	Input 6	12	Output 6
3	Input 3	8	Input 7	13	Output 7
4	Input 4	9	Input 8	14	Output 8
5	P24	10	Mext	15	Minput

6.3. Connector X7

20-pin ribbon cable connector, analog outputs

Pin	Signal	Pin	Signal
1	Channel 1	9	Channel 5
2	GND	10	GND
3	Channel 2	11	Channel 6
4	GND	12	GND
5	Channel 3	13	Channel 7
6	GND	14	GND
7	Channel 4	15	Channel 8
8	GND	16	GND

7. Supplementary components

Technology plug-in card IM1 Technology plug-in card IM3 Technology plug-in card IT1 Technology plug-in card IO3 Technology plug-in card ID3 with retaining screws/bolts Item No. SE 113004.9101.00 order from PSWE presently being prepared T89120-E3169 presently being prepared presently being prepared

User libraries for STRUC with FBs for EP3 EP3 compiler EP3C EP3 programming tool EP3MC Diagnostics program EP3IBS Motorola DSP Development Software contact ASI 1 G KT

In addition, to generate new function blocks: INTEL-UDI tools FB generator for STRUC and DSP

In addition, to generate new LCA designs: CAD tools, e.g. Viewlogic XILINX software to generate LCAs

8. ESD instructions

Components which can be destroyed by electrostatic discharge (ESD)

Generally, electronic boards should only be touched when absolutely necessary.

The human body must be electrically discharged before touching an electronics board. This can be simply done by touching a conductive, grounded object directly beforehand (e.g. bare metal cubicle components, socket outlet protective conductor contact).

Boards may not come into contact with highly-insulating materials - e.g. plastic foils, insulated desktops, articles of clothing manufactured from man-made fibers.

Boards may only be placed on conductive surfaces.

When soldering, the soldering iron tip must be grounded.

Boards and components should only be stored and transported in conductive packaging (e.g. metalized plastic boxes, metal containers).

If the packing material is not conductive, the boards must be wrapped with a conductive packing material, e.g. conductive foam rubber or household aluminum foil.

The necessary ESD protective measures are clearly shown in the following diagram.



d = ESD overall e = ESD chain f = Cabinet ground connection



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System-Based Drive Technology

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